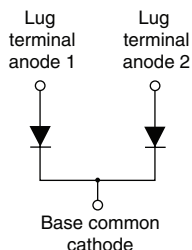


# HEXFRED® Ultrafast Soft Recovery Diode, 167 A



TO-244



## FEATURES

- Very low  $Q_{rr}$  and  $t_{rr}$
- Lead (Pb)-free
- Designed and qualified for industrial level


RoHS  
COMPLIANT

## BENEFITS

- Reduced RFI and EMI
- Reduced snubbing

## DESCRIPTION

HEXFRED® diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and  $dI/dt$  simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

## PRODUCT SUMMARY

$I_F$ (maximum)	167 A
$V_R$	600 V
$I_{F(DC)}$ at $T_C$	84 A at 100 °C

## ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Cathode to anode voltage	$V_R$		600	V
Continuous forward current	$I_F$	$T_C = 25\text{ °C}$	167	A
		$T_C = 100\text{ °C}$	84	
Single pulse forward current	$I_{FSM}$	Limited by junction temperature	400	
Non-repetitive avalanche energy	$E_{AS}$	$L = 100\text{ }\mu\text{H}$ , duty cycle limited by maximum $T_J$	330	$\mu\text{J}$
Maximum power dissipation	$P_D$	$T_C = 25\text{ °C}$	310	W
		$T_C = 100\text{ °C}$	132	
Operating junction and storage temperature range	$T_J, T_{Stg}$		- 55 to + 150	°C

## ELECTRICAL SPECIFICATIONS PER LEG ( $T_J = 25\text{ °C}$ unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V <sub>BR</sub>	I <sub>R</sub> = 100 μA		600	-	-	V
Maximum forward voltage	V <sub>FM</sub>	I <sub>F</sub> = 70 A	See fig. 1	-	1.37	1.89	
		I <sub>F</sub> = 140 A		-	1.58	2.1	
		I <sub>F</sub> = 70 A, T <sub>J</sub> = 125 °C		-	1.29	1.54	
Maximum reverse leakage current	I <sub>RM</sub>	T <sub>J</sub> = 125 °C, V <sub>R</sub> = 480 V	See fig. 2	-	1.2	4	mA
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 200 V	See fig. 3	-	140	250	pF
Series inductance	L <sub>S</sub>	From top of terminal hole to mounting plane		-	7.0	-	nH

DYNAMIC RECOVERY CHARACTERISTICS (T <sub>J</sub> = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time See fig. 5	t <sub>rr</sub>	I <sub>F</sub> = 1.0 A, dI <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> = 30 V	-	33	-	ns
		T <sub>J</sub> = 25 °C	-	80	120	
		T <sub>J</sub> = 125 °C	-	140	220	
Peak recovery current See fig. 6	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C	-	8.5	15	A
		T <sub>J</sub> = 125 °C	-	14	25	
Reverse recovery charge See fig. 7	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C	-	340	900	nC
		T <sub>J</sub> = 125 °C	-	980	2300	
Peak rate of recovery current See fig. 8	dI <sub>(rec)</sub> /dt	T <sub>J</sub> = 25 °C	-	300	-	A/μs
		T <sub>J</sub> = 125 °C	-	220	-	

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>	- 55	-	150	°C
Thermal resistance, junction to case	R <sub>thJC</sub>	-	-	0.38	°C/W K/W
		-	-	0.19	
Typical thermal resistance, case to heatsink	R <sub>thCS</sub>	-	0.10	-	
Weight		-	68	-	g
		-	2.4	-	oz.
Mounting torque <sup>(1)</sup>		30 (3.4)	-	40 (4.6)	N · m (lbf · in)
Mounting torque center hole		12 (1.4)	-	18 (2.1)	
Terminal torque		30 (3.4)	-	40 (4.6)	
Vertical pull		-	-	80	lbf · in
2" lever pull		-	-	35	

**Note**

<sup>(1)</sup> Mounting surface must be smooth, flat, free of burrs or other protrusions. Apply a thin even film of thermal grease to mounting surface. Gradually tighten each mounting bolt in 5 - 10 lbf · in steps until desired or maximum torque limits are reached

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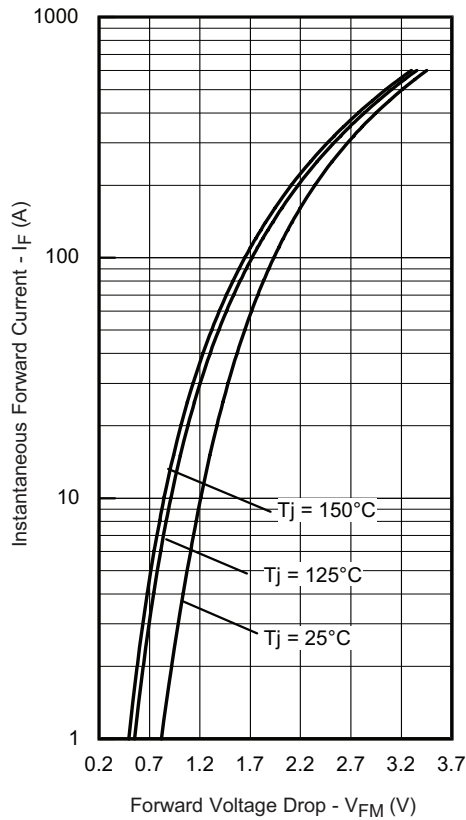


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current (Per Leg)

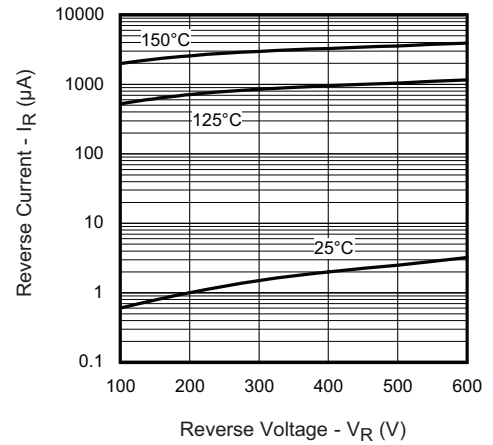


Fig. 2 - Typical Reverse Current vs. Reverse Voltage (Per Leg)

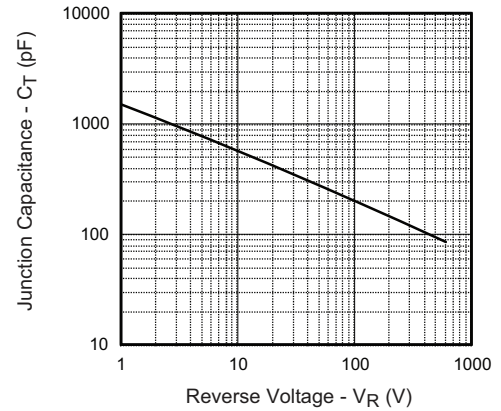


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

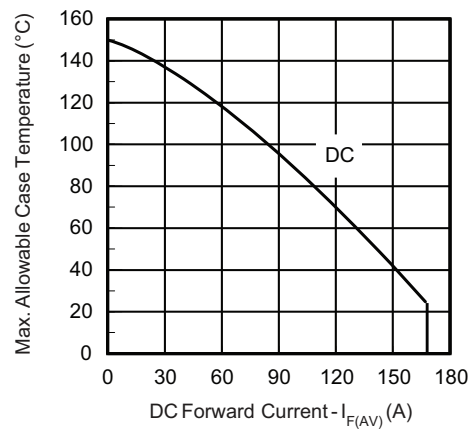


Fig. 4 - Maximum Allowable Case Temperature vs. DC Forward Current (Per Leg)

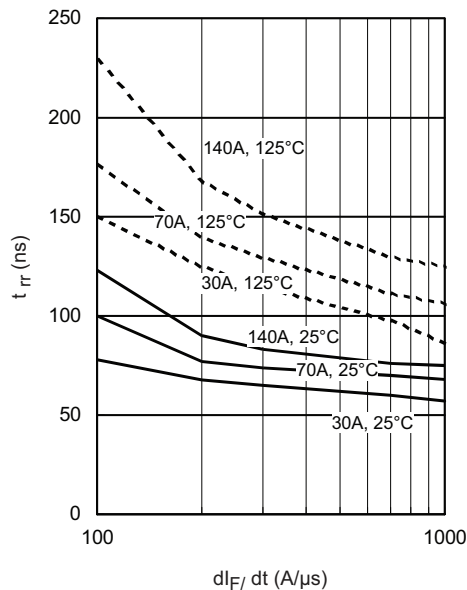


Fig. 5 - Typical Reverse Recovery Time vs.  $dI_F/dt$  (Per Leg)

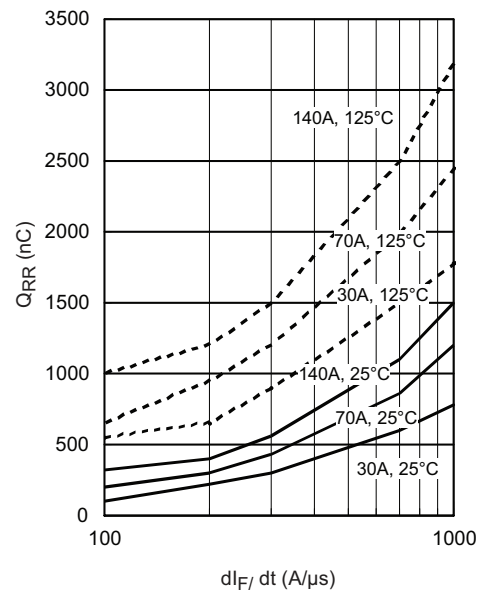


Fig. 7 - Typical Stored Charge vs.  $dI_F/dt$  (Per Leg)

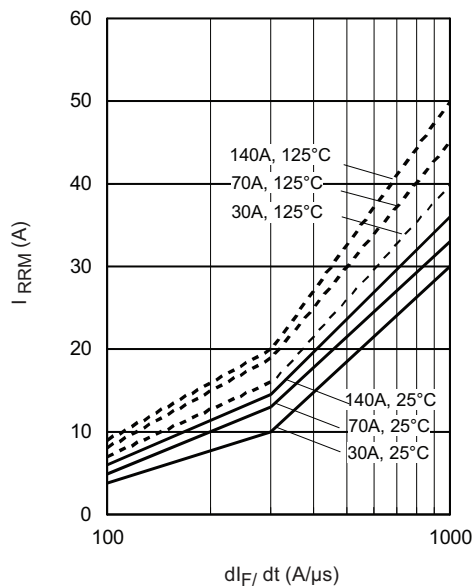


Fig. 6 - Typical Recovery Current vs.  $dI_F/dt$  (Per Leg)

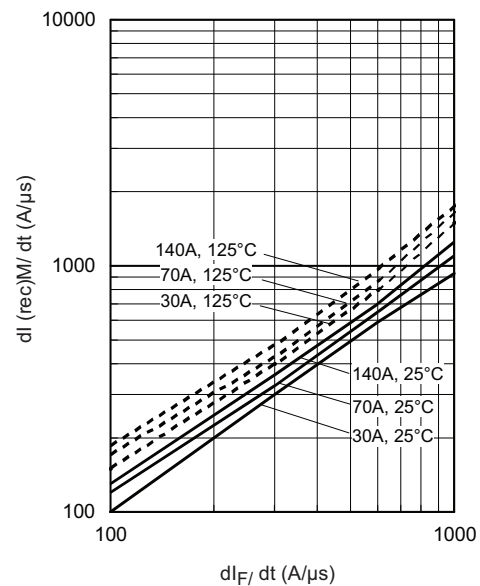


Fig. 8 - Typical  $dI_{(rec)M}/dt$  vs.  $dI_F/dt$  (Per Leg)

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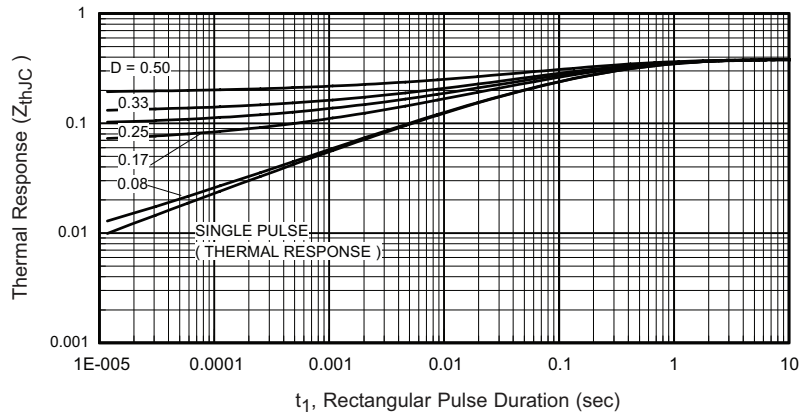


Fig. 9 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

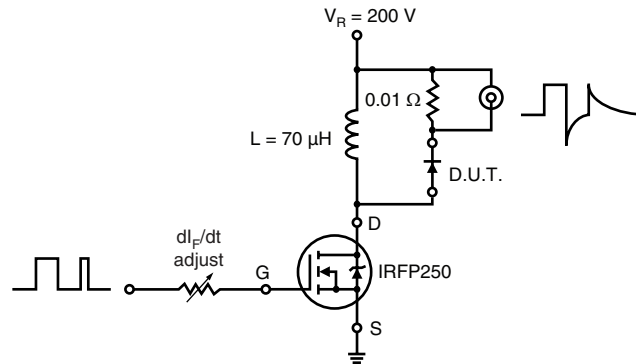


Fig. 10 - Reverse Recovery Parameter Test Circuit

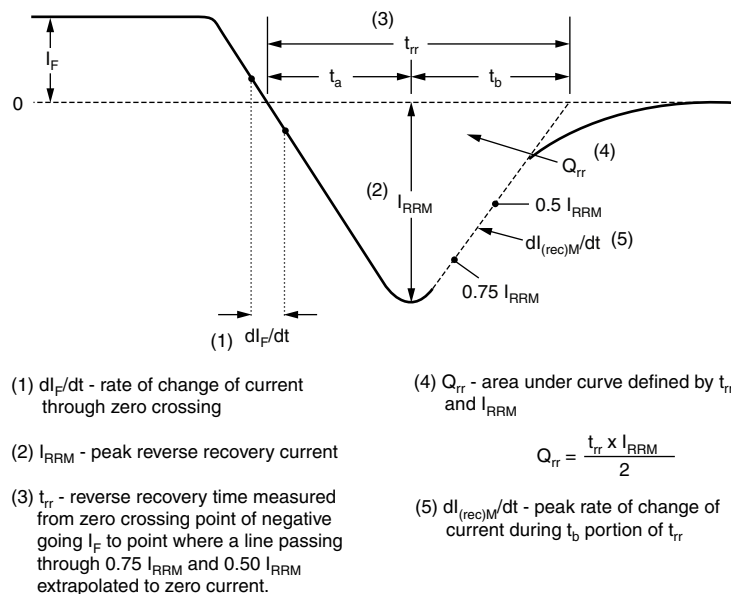


Fig. 11 - Reverse Recovery Waveform and Definitions

# HFA140NJ60CPbF

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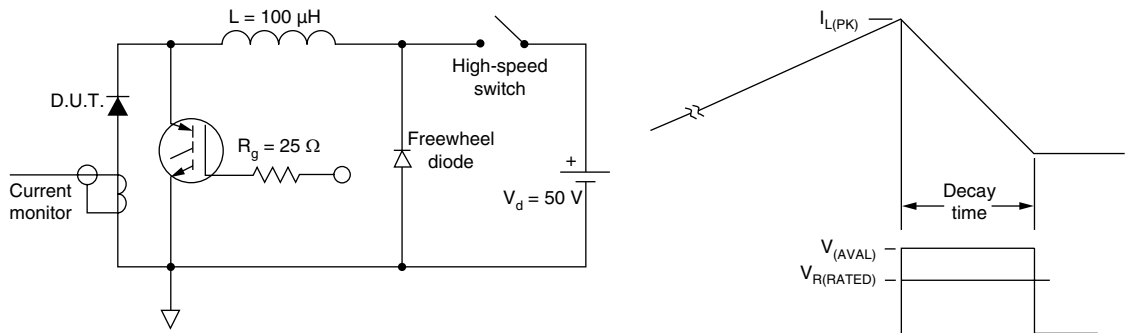


Fig. 12 - Avalanche Test Circuit and Waveforms

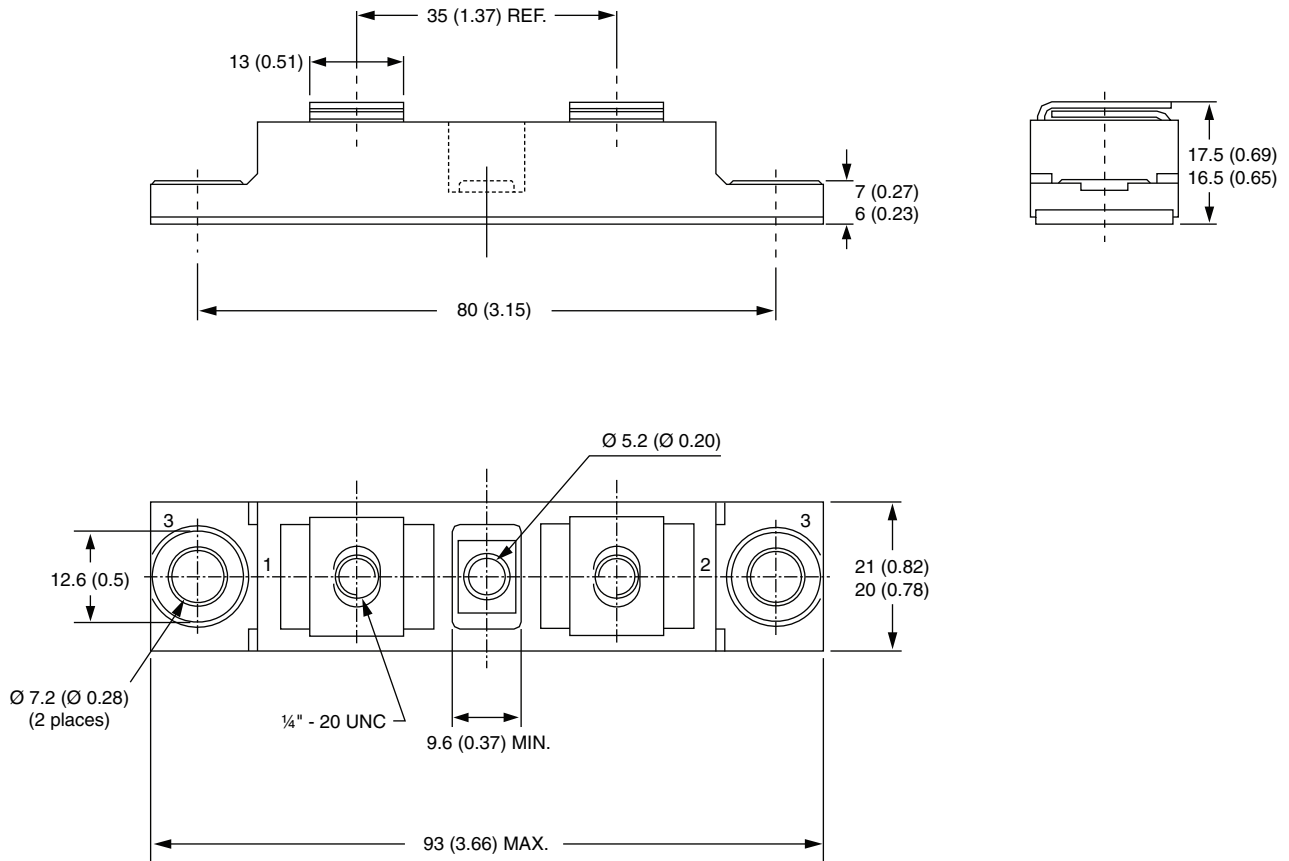
## ORDERING INFORMATION TABLE

Device code	HFA	140	NJ	60	C	PbF
	1	2	3	4	5	6
1	- HEXFRED® family					
2	- Average current rating					
3	- NJ = TO-244					
4	- Voltage rating (600 V)					
5	- C = Common cathode					
6	- Lead (Pb)-free					

LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95021">http://www.vishay.com/doc?95021</a>

## TO-244

**DIMENSIONS** in millimeters (inches)





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